

### **Automotive MOSFET**

### **OptiMOS™-5 Power-Transistor**







### **Features**

- OptiMOS<sup>™</sup> power MOSFET for automotive applications
- N-channel Enhancement mode Logic Level
- Extended qualification beyond AEC-Q101
- Enhanced electrical testing
- Robust design
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- Green product (RoHS compliant)
- 100% Avalanche tested

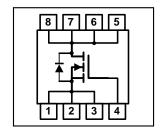


General automotive applications.



Qualified for automotive applications. Product validation according to AEC-Q101.





**Product Summary** 

$V_{DS}$	60	٧
R <sub>DS(on)</sub>	1.50	mΩ
I <sub>D</sub> (chip limited)	235	Α

Туре	Package	Marking
IAUC120N06S5L015	PG-TDSON-8-43	5N06L015

### IAUC120N06S5L015



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# **Maximum ratings**

at Tj=25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I <sub>D</sub>	V <sub>GS</sub> =10 V, Chip limitation <sup>1,2)</sup>	235	А
		V <sub>GS</sub> =10V, DC current <sup>3)</sup>	120	
		$T_a$ =85 °C, $V_{GS}$ =10 V, $R_{thJA}$ on 2s2p <sup>2,4)</sup>	36	
Pulsed drain current <sup>2)</sup>	/ <sub>D,pulse</sub>	$T_{\rm C}$ =25 °C, $t_{\rm p}$ = 100 μs	810	
Avalanche energy, single pulse <sup>2)</sup>	E AS	/ <sub>D</sub> =60 A	345	mJ
Avalanche current, single pulse	I <sub>AS</sub>	-	120	А
Gate source voltage	V <sub>GS</sub>	-	±20	V
Power dissipation	P <sub>tot</sub>	T <sub>C</sub> =25 °C	167	W
Operating and storage temperature	$T_{\rm j}, T_{\rm stg}$	-	-55 <b>+1</b> 75	°C
IEC climatic category; DIN IEC 68-1	-	-	55/175/56	

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# Thermal characteristics<sup>2)</sup>

Parameter	Symbol	Conditions	Values		Unit	
			min.	typ.	max.	
Thermal resistance, junction - case	R thJC	-	-	-	0.90	K/W
Thermal resistance, junction - ambient <sup>4)</sup>	R <sub>thJA</sub>	-	-	23.5	-	

## **Electrical characteristics**

at Tj=25 °C, unless otherwise specified

Parameter	Symbol	Symbol Conditions	Values			Unit
			min.	typ.	max.	
Static characteristics						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ =0 V, $I_{D}$ =1 mA	60	-	-	V
Gate threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 94 \mu A$	1.2	1.7	2.2	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{\rm DS}$ =60 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C	_	-	1	μΑ
		$V_{DS}$ =60 V, $V_{GS}$ =0 V, $T_{j}$ =100 °C <sup>2</sup> )	_	-	100	
Gate-source leakage current	I <sub>GSS</sub>	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V	-	-	100	nA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =4.5 V, I <sub>D</sub> =60 A	-	1.73	2.13	mΩ
		V <sub>GS</sub> =10 V, I <sub>D</sub> =60 A	-	1.22	1.50	
Gate resistance <sup>2)</sup>	R <sub>G</sub>	-	-	1.6	_	Ω

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Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Dynamic characteristics <sup>2)</sup>						
Input capacitance	C iss		-	6302	8193	pF
Output capacitance	C oss	$V_{GS}$ =0 V, $V_{DS}$ =30 V, $f$ =1 MHz	-	1161	1509	
Reverse transfer capacitance	C <sub>rss</sub>		-	54	81	
Turn-on delay time	t <sub>d(on)</sub>		_	9	-	ns
Rise time	t <sub>r</sub>	$V_{DD}$ =30 V, $V_{GS}$ =10 V, $I_{D}$ =60 A,	_	6	-	
Turn-off delay time	t d(off)	$R_{\rm G}$ =3.5 $\Omega$	_	45	_	
Fall time	t f	1	_	24	_	
Gate Charge Characteristics <sup>2)</sup>	0		_	10	22	nC
<del></del>		<u> </u>		_		Ι.
Gate Charge Characteristics <sup>2)</sup> Gate to source charge Gate to drain charge	Q gs Q gd	V <sub>DD</sub> =30 V, I <sub>D</sub> =60 A,	-	18 14	23	nC
Gate to source charge		V <sub>DD</sub> =30 V, I <sub>D</sub> =60 A, V <sub>GS</sub> =0 to 10 V		_		nC
Gate to source charge Gate to drain charge	Q <sub>gd</sub>	<u>_</u> }	-	14	21	nC V
Gate to source charge  Gate to drain charge  Gate charge total	Q <sub>gd</sub>	<u>_</u> }	-	14	21	
Gate to source charge  Gate to drain charge  Gate charge total  Gate plateau voltage	Q <sub>gd</sub>	<u>_</u> }	-	14	21	
Gate to source charge  Gate to drain charge  Gate charge total  Gate plateau voltage  Reverse Diode  Diode continous forward current <sup>2)</sup>	Q gd Q g	V <sub>GS</sub> =0 to 10 V	-	14 88 2.9	21	V
Gate to source charge  Gate to drain charge  Gate charge total  Gate plateau voltage  Reverse Diode  Diode continous forward current <sup>2)</sup> Diode pulse current <sup>2)</sup>	Q gd Q g V plateau	V <sub>GS</sub> =0 to 10 V T <sub>C</sub> =25 °C		14 88 2.9	21 114 - 120	V
Gate to source charge  Gate to drain charge  Gate charge total  Gate plateau voltage  Reverse Diode	Q gd Q g V plateau	$V_{GS}$ =0 to 10 V $T_{C}$ =25 °C $T_{C}$ =25 °C, $t_{p}$ = 100 $\mu$ s		14 88 2.9	21 114 - 120 815	V

<sup>1)</sup> Practically the current is limited by the overall system design including the customer-specific PCB.

 $<sup>^{\</sup>rm 2)}$  The parameter is not subject to production testing – specified by design.

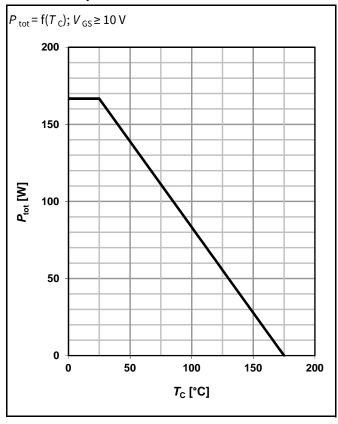
<sup>&</sup>lt;sup>3)</sup> Current is limited by package.

 $<sup>^{4)}</sup>$  Device on 2s2p FR4 PCB defined in accordance with JEDEC standards (JESD51-5, -7). PCB is vertical in still air.

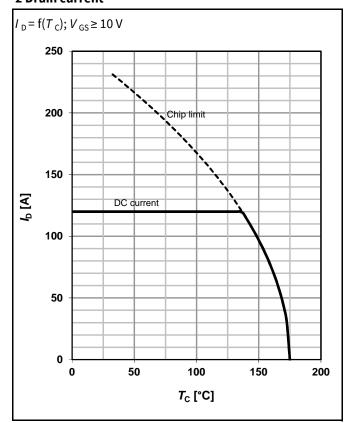


## **Electrical characteristics diagrams**

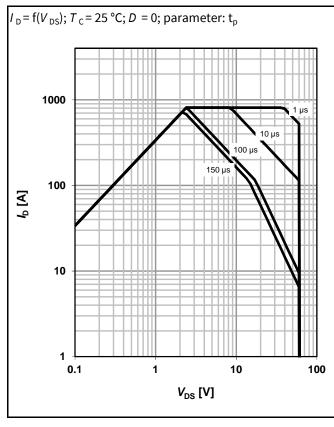
### 1 Power dissipation



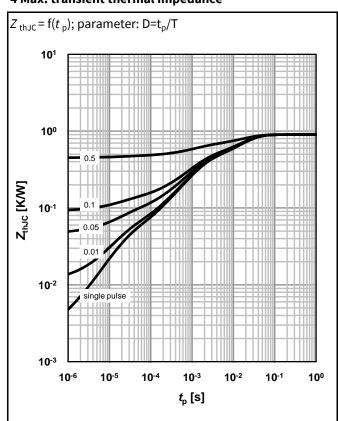
### 2 Drain current



### 3 Safe operating area

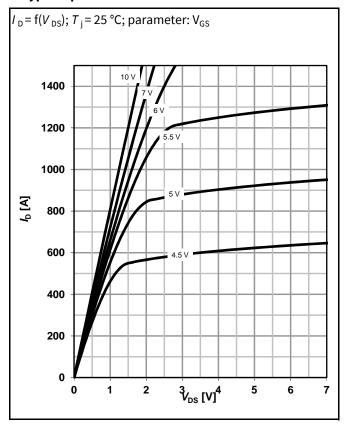


### 4 Max. transient thermal impedance

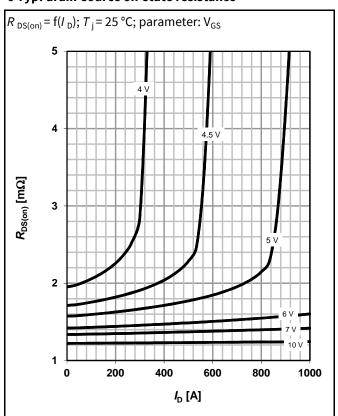




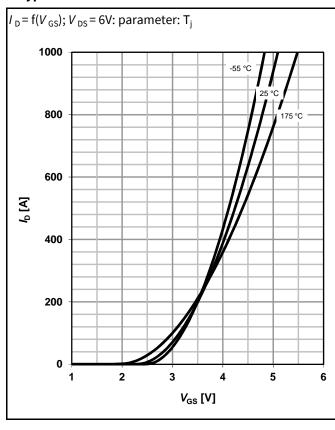
### 5 Typ. output characteristics



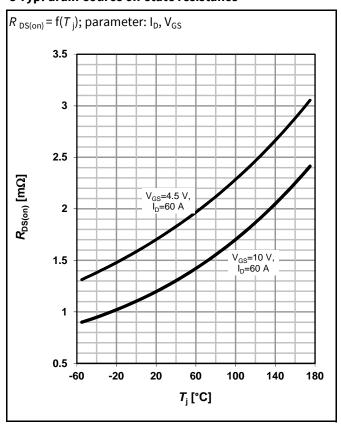
### 6 Typ. drain-source on-state resistance



### 7 Typ. transfer characteristics

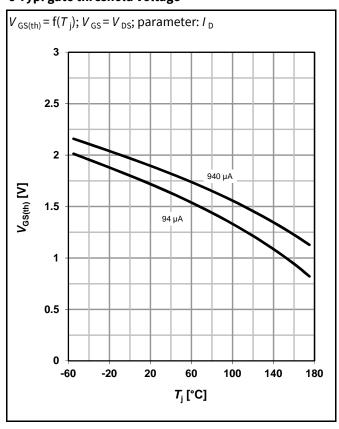


### 8 Typ. drain-source on-state resistance

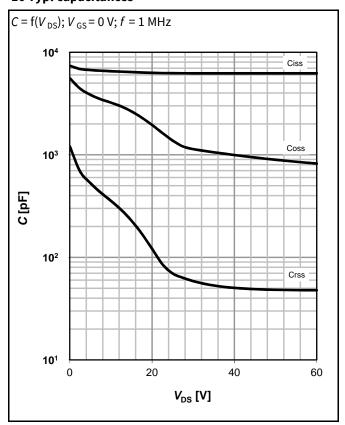


# infineon

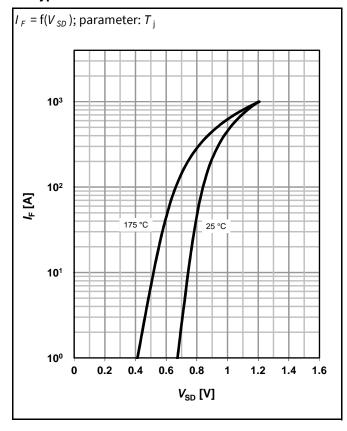
### 9 Typ. gate threshold voltage



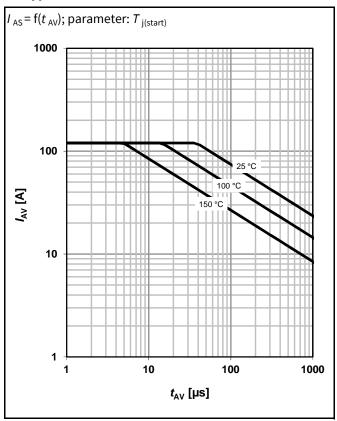
### 10 Typ. capacitances



### 11 Typical forward diode characteristics



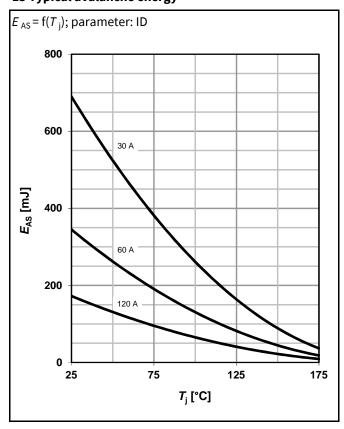
### 12 Typ. avalanche characteristics



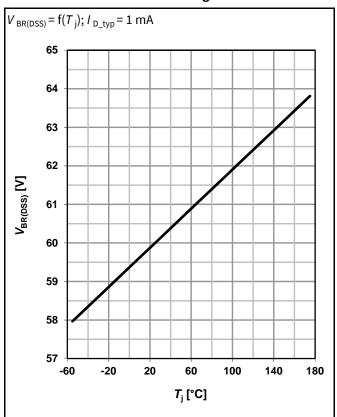
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# infineon

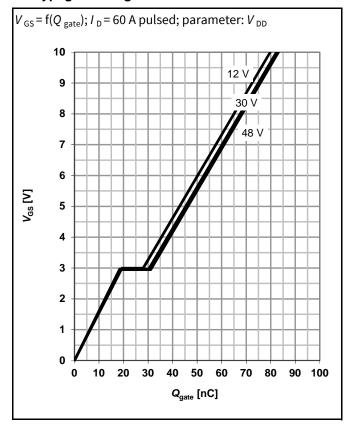
### 13 Typical avalanche energy



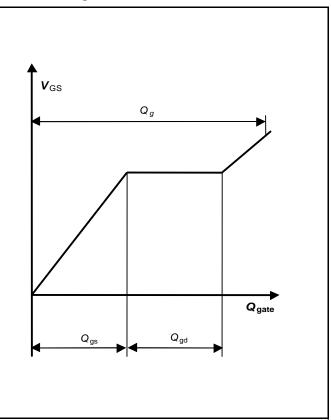
### 14 Drain-source breakdown voltage



### 15 Typ. gate charge



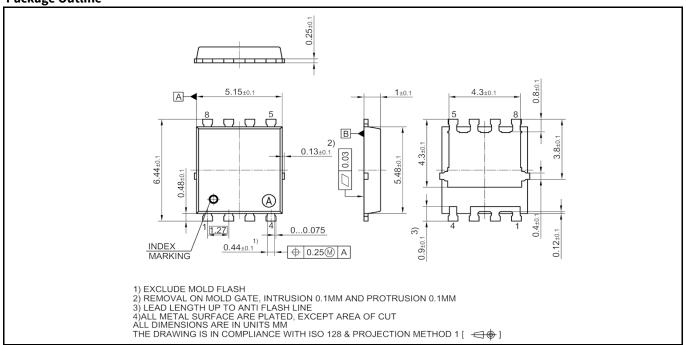
### 16 Gate charge waveforms



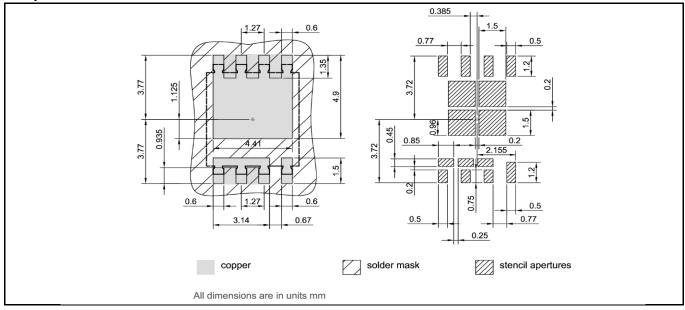
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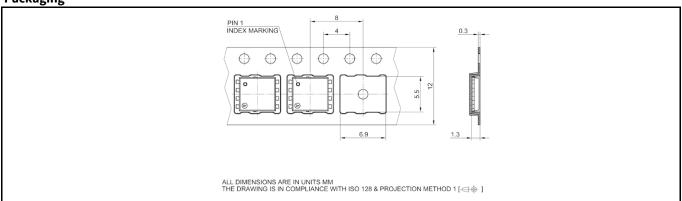
**Package Outline** 



### **Footprint**



### **Packaging**



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## **Revision History**

Revision	Date	Changes
Revision 1.0	12.07.2022	Final Data Sheet

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